

**Customer Notification** 

# QB-703426

# **In-Circuit-Emulator**

**Operating Precautions** 

Target Device - V850E/Dx3

uPD70(F)3424/425/426<sup>TM</sup>

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### (A) Table of Operating Precautions

|     |   |                    |                          | QB-70                    | 03426 |  |
|-----|---|--------------------|--------------------------|--------------------------|-------|--|
|     |   | CtrlCode           | ,                        | ٩                        |       |  |
|     |   | Date               | 08.06.06                 | 07.04.08                 |       |  |
|     |   | Version IO         | V1.20-1.40<br>V2.00-2.10 | V1.20-1.40<br>V2.00-2.10 |       |  |
|     |   | Version FPGA<br>IO | V4.02                    | V4.05                    |       |  |
|     |   | Version VM         | V1.01                    | V1.01                    |       |  |
| No. | Outline   | Version FPGA<br>VM | V1.00                    | V1.00                    |       |  |
| 1   | Internal On-chip oscillator frequency is fixed (Technical limitation)                 | d to 200 kHz       | Y                        | Y                        |       |  |
| 2   | Fout- and WDT-clock supply differ from de<br>by mode<br>(Specification change notice) | Y                  | Y                        |                          |       |  |
| 3   | PSM.OSCDIS reset value different to devic<br>(Specification change notice)            | Y                  | Y                        |                          |       |  |
| 4   | Timing different to device for oscillation stat<br>(Specification change notice)      | Y                  | Y                        |                          |       |  |
| 5   | Break precaution related to ADC macro (Specification change notice)                   | Y                  | Y                        |                          |       |  |
| 6   | Open-Drain Port mode not implemented (Technical limitation)                           | Y                  | Ν                        |                          |       |  |
|     |   |                    |                          |                          |       |  |
|     |   |                    |                          |                          |       |  |
|     |   |                    |                          |                          |       |  |
|     |   |                    |                          |                          |       |  |
|     |   |                    |                          |                          |       |  |
|     |   |                    |                          |                          |       |  |

#### N: Not applicable

#### Y: Applicable

Note: The control code is the second letter from the left of the 10 digit serial number or in case of update the latest control code is mentioned on the version up sticker.

# (B) Description of Operating Precautions

| <u>Details:</u><br>The internal On-chip oscillator frequency may differ from the device version to be emulated.<br><u>Workaround:</u><br>None | No. 1 | Internal On-chip oscillator frequency is fixed to 200 kHz   |  |  |  |
|---|-------|---|--|--|--|
|   |       | <u>Details:</u><br>The internal On-chip oscillator frequency may differ from the device version to be emulated.<br><u>Workaround:</u><br>None |  |  |  |

| No. 2 | Fout- and WDT-clock supply differ from device in stand by mode   |
|-------|--|
|       | Details:      In stand by mode, the FOUT clock supply (Internal On-chip oscillator clock, if ROSTP=1 is set) will not stop.      In stand by mode, the FOUT clock supply (Sub-clock, if SOSTP=1 is set) will not stop.      In stand by mode, the WDT clock supply (Internal On-chip oscillator clock, if ROSTP=1 is set) will not stop.      In stand by mode, the WDT clock supply (Internal On-chip oscillator clock, if ROSTP=1 is set) will not stop.      In stand by mode, the WDT clock supply (Sub-clock, if SOSTP=1 is set) will not stop.      In stand by mode, the WDT clock supply (Sub-clock, if SOSTP=1 is set) will not stop.      Morkaround:      None. |

| No. 3 | PSM.OSCDIS reset value different to device   |  |  |
|-------|--|--|--|
|       | Details:<br>The reset value of the OSCDIS is '1'. On real chip OSCDIS is set to '0' during firmware execution.                       |  |  |
|       | Workaround:<br>Initialise the OSCDIS after RESET or use the functions of the Debugger to initialize the OSCDIS before program start. |  |  |
|       |  |  |  |
|       |  |  |  |
| No. 4 | Timing different to device for oscillation stabilization time  |  |  |

<u>Workaround:</u> None

| No. 5 | Break precaution related to ADC macro   |  |  |
|-------|---|--|--|
|       | Details: [Explanation]  |  |  |
|       | The following Behaviour is valid for the IECUBE emulator "only" in case the peripheral break mode is active for the ADC macro:  |  |  |
|       | 1.) In case the peripheral break signal (SVSTOP = 1) is set while or<br>after the conversion control bit ADA0CE has been set, the AD<br>conversion is not started and the concerned interrupt INTAD will not be<br>generated. Furthermore the AD conversion will not start conversion even in<br>case the Supervisor mode has been left and the debugger operates in RUN<br>mode. |  |  |
|       | In case the ADA0CE bit will be set during normal RUN mode again without issuing the peripheral break signal, the ADC will operate as specified.   |  |  |
|       | The conditions the peripheral break signal is issued are as follows:  |  |  |
|       | a.) - When one of these break is executed on the AD0ACE bit write<br>instruction<br>Software break<br>Before-execution hardware break<br>After-execution hardware break   |  |  |
|       | b.) - When one of these break is executed on the first instruction<br>following the AD0ACE bit write instruction<br>Software break<br>Before-execution hardware break   |  |  |
|       | c.) - When the following break is executed on the second instruction<br>following the AD0ACE bit write instruction<br>Software break  |  |  |
|       | 2.) In case the peripheral break mode (SVSTOP=1) has been configured and the debugger operates in the debug (supervisor-) mode, a write operation to the ADC concerned registers:   |  |  |
|       | ADA0M0, (ADA0M1(#)), ADA0M2, ADA0S, ADA0PFT, ADAPFM (#) when ADA0CE=1, the re-write of ADA0M1 is prohibited and will not cause the start of the ADC's reconversion.   |  |  |
|       | It doesn't make a difference if the concerned write operations to the<br>above mentioned ADC registers are executed via the debugger itself or via<br>DMA that is not stopped when entering the supervisor mode. Both write<br>operations will cause the limitation.  |  |  |
|       |   |  |  |

| No. 5 | Break precaution related to ADC macro (2nd page)   |  |  |
|-------|--|--|--|
|       | Workaround: [Restrictions]   |  |  |
|       | a) When a software break is executed in case the peripheral break mode has<br>been configured for the ADC macro, set the software break not for the<br>instruction the ADA0CE bit is set or at one of the following two<br>instructions:   |  |  |
|       | Example:   |  |  |
|       | set1 7, ADA0M0 software break is prohibited<br>nop software break is prohibited<br>nop software break is prohibited<br>nop software break is possible to set from here on  |  |  |
|       | b) When a "before-execution hardware break" is executed and the peripheral break mode has been configured for the ADC macro, don't set that breakpoint for the instruction that sets the ADA0CE bit or for the following instruction:  |  |  |
|       | Example:   |  |  |
|       | set1 7, ADA0M0 before-execution hardware break is prohibited<br>nop before-execution hardware break is prohibited<br>nop before-execution hardware break is possible to set from here on   |  |  |
|       | c) When a "before-execution hardware break" is executed in peripheral<br>break mode and the peripheral break mode has been configured for the ADC<br>macro, don't set that breakpoint for the instruction that sets the ADA0CE<br>bit:   |  |  |
|       | Example:   |  |  |
|       | set1 7, ADA0M0 after-execution hardware break is prohibited<br>nop after-execution hardware break is possible to set from here on  |  |  |
|       | d) When users want to proceed the write operation for the AD related registers during BREAK (debugger operates within the supervisor mode), don't use peripheral break mode.   |  |  |
|       | e) When users want to proceed the DMA transfer which has AD related registers set as source/destination for this DMA transfer <<<, don't use peripheral break mode.  |  |  |
|       | Note: In case a condition mentioned under "Workarounds: a), b), c)" will occur when setting one of the concerned breakpoints on the location of an interrupt-vector, no limitation will become valid due to the clock-cycles that are requested for the interrupt-response time! |  |  |

| No. 6 | Open-Drain Port mode not implemented  |  |  |
|-------|---|--|--|
|       | <u>Details:</u><br>The register access (read/write) of PODCx is possible, but the function itself isn't supported. The following Port is affected: P0[7]. |  |  |
|       | <u>Workaround:</u><br>None  |  |  |

# (C) Valid Specification

| ltem | Date published | Document No.     | Document Title                      |
|------|----------------|------------------|-------------------------------------|
| 1    | April 2008     | EEDT-OP-0033-5.0 | This document                       |
| 2    | April 2007     | U18352EE1V0UM00  | Preliminary User's Manual QB-703426 |
| 3    | April 2007     | U18350EE1V0UM00  | Preliminary User's Manual QB-703427 |
|      |                |                  |                                     |

## (D) Revision History

| ltem | Date published | Document No.     | Comment                        |
|------|----------------|------------------|--------------------------------|
| 1    | June 2006      | EEDT-OP-0033-1.0 | 1st release                    |
| 2    | April 2007     | EEDT-OP-0033-2.0 | 1st update (new UM)            |
| 3    | July 2007      | EEDT-OP-0033-3.0 | 2nd update (Text correction)   |
| 4    | November 2007  | EEDT-OP-0033-4.0 | 3rd update (New item No. 6)    |
| 5    | April 2008     | EEDT-OP-0033-5.0 | 4th update (Update item No. 6) |
|      |                |                  |                                |